# **TECHNICAL DATA SHEET**



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Very thin double coated adhesive tape

# DAITAC® #8603TNW-10

### Construction



#### Characteristics

- ✓ Tape thickness is 10  $\mu$  m.
- ✓ Good die-cutting workability
- ✓ Good workability.
- ✓ Product does not use the 6 restrictive substances of the RoHS Directive.

#### Applications

- ✓ For attaching thin sheet for mobile electronic equipment.
- ✓ For bonding heat dissipating material such as graphite sheet.
- ✓ For attaching magnetic sheet.

#### Properties

Test item	Condition	Substrate	Unit	#8603TNW-10
Thickness	Except release liner	-	μm	10
180 deg. peel strength	23°C, 1hr	SUS (hairline)	N/20mm	8
Static shear	100°C, 0.1kg	SUS (hairline)	hr	24 <

Size

1,000mm in max width 100-150m in length

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#### Composite Solutions BU

#### https://www.dic-global.com/en/products/adhesive\_tapes/

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